

## PRELIMINARY DATA

### BCD-TO-SEVEN SEGMENT LATCH/DECODER/DRIVER

- HIGH-OUTPUT-SOURCING CAPABILITY (up to 25 mA)
- INPUT LATCHES FOR BCD CODE STORAGE
- LAMP TEST AND BLANKING CAPABILITY
- 7-SEGMENT OUTPUTS BLANKED FOR BCD INPUT CODES > 1001
- QUIESCENT CURRENT SPECIFIED TO 20V
- MAXIMUM INPUT LEAKAGE OF 1  $\mu$ A AT 18V (FULL PACKAGE-TEMPERATURE RANGE)
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- 5V, 10V, AND 15V PARAMETRIC RATINGS

The **HCC 4511B** (extended temperature range) and the **HCF 4511B** (intermediate temperature range) are monolithic integrated circuits available in 16-lead dual in-line plastic or ceramic package and ceramic flat package.

The **HCC/HCF 4511B** types are BCD-to-7-segment latch decoder drivers constructed with COS/MOS logic and n-p-n bipolar transistor output devices on a single monolithic structure. These devices combine the low quiescent power dissipation and high noise immunity features of COS/MOS with n-p-n bipolar output transistors capable of sourcing up to 25 mA. This capability allows the **HCC/HCF 4511B** types to drive LED's and other displays directly.

Lamp Test (LT), Blanking (BL), and Latch Enable or Strobe inputs are provided to test the display, shut off or intensity-modulate it, and store or strobe a BCD code, respectively. Several different signal may be multiplexed and displayed when external multiplexing circuitry is used.

### ABSOLUTE MAXIMUM RATINGS

$V_{DD}^*$	Supply voltage	-0.5 to 20	V
$V_I$	Input voltage	-0.5 to $V_{DD} + 0.5$	V
$I_I$	DC input current (any one input)	$\pm 10$	mA
$P_{tot}$	Total power dissipation (per package)	200	mW
	Dissipation per output transistor		
	for $T_{op}$ = full package-temperature range	100	mW
$T_{op}$	Operating temperature: for <b>HCC</b> types	-55 to 125	$^{\circ}$ C
	for <b>HCF</b> types	-40 to 85	$^{\circ}$ C
$T_{stg}$	Storage temperature	-65 to 150	$^{\circ}$ C

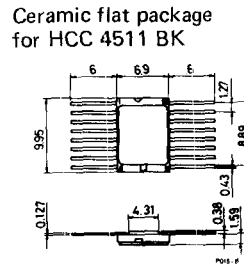
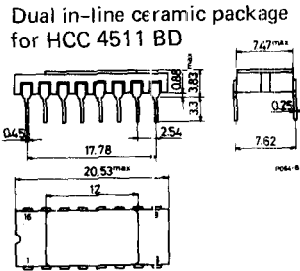
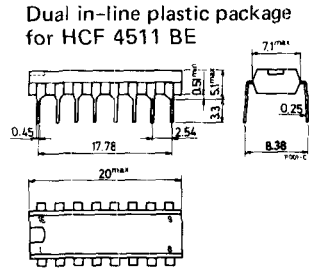
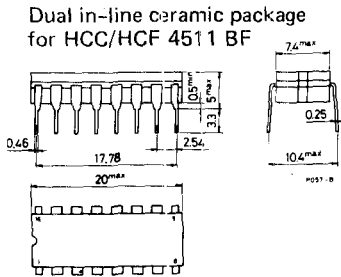
\* All voltage values are referred to  $V_{SS}$  pin voltage

### ORDERING NUMBERS:

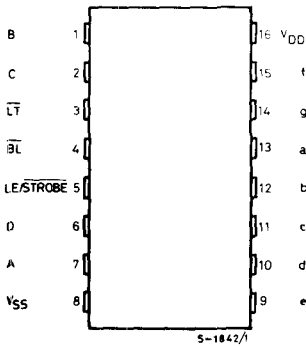
- HCC 4511 BD for dual in-line ceramic package
- HCC 4511 BF for dual in-line ceramic package, frit seal
- HCC 4511 BK for ceramic flat package
- HCF 4511 BE for dual in-line plastic package
- HCF 4511 BF for dual in-line ceramic package, frit seal

# HCC/HCF 4511 B

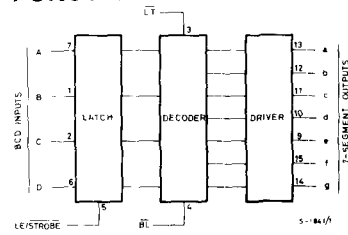
## MECHANICAL DATA (dimensions in mm)



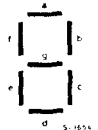
## CONNECTION DIAGRAM



## FUNCTIONAL DIAGRAM



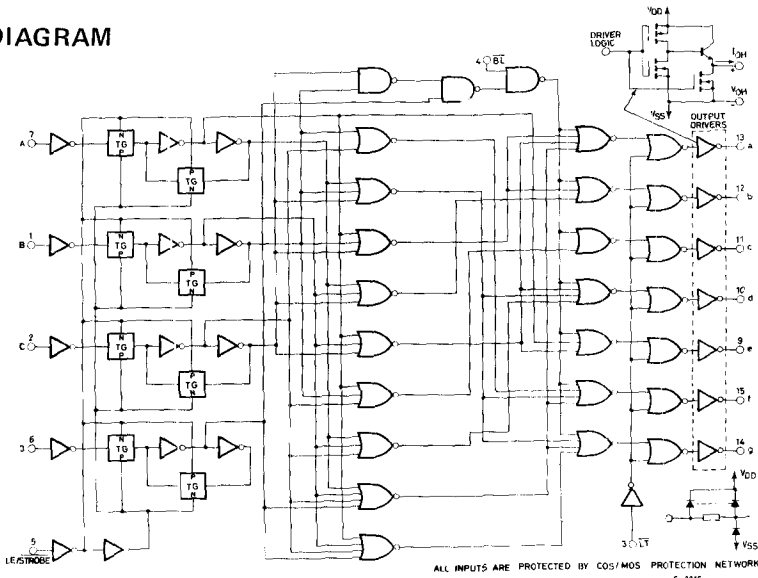
## DISPLAY



## RECOMMENDED OPERATING CONDITIONS

$V_{DD}$	Supply voltage	3 to 18	V
$V_I$	Input voltage	0 to $V_{DD}$	V
$T_{op}$	Operating temperature: for HCC types	-55 to 125	°C
	for HCF types	-40 to 85	°C

LOGIC DIAGRAM

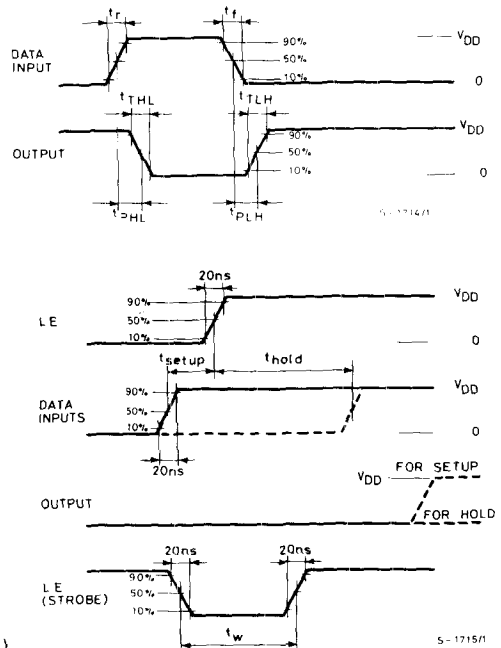


TRUTH TABLE

LE	BI	LT	D	C	B	A	a	b	c	d	e	f	g	Display
X	X	0	X	X	X	X	1	1	1	1	1	1	1	8
X	0	1	X	X	X	X	0	0	0	0	0	0	0	Blank
0	1	1	0	0	0	0	1	1	1	1	1	1	0	0
0	1	1	0	0	0	1	0	1	1	0	0	0	0	1
0	1	1	0	0	1	0	1	1	0	1	1	0	1	2
0	1	1	0	0	1	1	1	1	1	0	0	1	1	3
0	1	1	0	1	0	0	0	1	1	0	0	1	1	4
0	1	1	0	1	0	1	1	0	1	1	0	1	1	5
0	1	1	0	1	1	0	0	0	1	1	1	1	1	6
0	1	1	0	1	1	1	1	1	0	0	0	0	0	7
0	1	1	1	0	0	0	1	1	1	1	1	1	1	8
0	1	1	1	0	0	1	1	1	0	0	1	1	1	9
0	1	1	1	0	1	0	0	0	0	0	0	0	0	Blank
0	1	1	1	0	1	1	0	0	0	0	0	0	0	Blank
0	1	1	1	1	0	1	0	0	0	0	0	0	0	Blank
0	1	1	1	1	1	0	0	0	0	0	0	0	0	Blank
0	1	1	1	1	1	1	0	0	0	0	0	0	0	Blank
1	1	1	X	X	X	X	*	*	*	*	*	*	*	*

X = Don't care  
 \* = Depends on BCD code previously applied when LE=0  
 Note: Display is blank for all illegal input codes {BCD > 1001}

WAVEFORMS



**STATIC ELECTRICAL CHARACTERISTICS** (over recommended operating conditions)

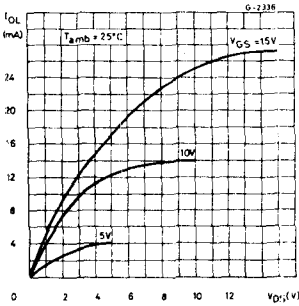
Parameter		Test conditions				Values						Unit								
		V <sub>I</sub> (V)	V <sub>O</sub> (V)	I <sub>OH</sub> (mA)	V <sub>DD</sub> (V)	T <sub>Low</sub> *		25°C			T <sub>High</sub> *									
						Min.	Max.	Min.	Typ.	Max.	Min.		Max.							
I <sub>L</sub>	Quiescent supply current				5		5	0.04	5		150	μA								
					10		10	0.04	10		300									
					15		20	0.04	20		600									
					20		100	0.08	100		3000									
V <sub>OH</sub>	Output high voltage	0/ 5			5	4		4.1	4.55		4.2	V								
		0/10			10	9		9.1	9.55		9.2									
		0/15			15	14		14.1	14.55		14.2									
V <sub>OL</sub>	Output low voltage	5/0			5		0.05			0.05	0.05	V								
		10/0			10		0.05			0.05	0.05									
		15/0			15		0.05			0.05	0.05									
V <sub>IH</sub>	Input high voltage		0.5/3.8		5	3.5		3.5			3.5	V								
			1/8.8		10	7		7			7									
			1.5/13.8		15	11		11			11									
V <sub>IL</sub>	Input low voltage		3.8/0.5		5		1.5			1.5	1.5	V								
			8.8/1		10		3			3	3									
			13.8/1.5		15		4			4	4									
V <sub>OH</sub>	Output drive voltage			0	5	4	4.10	4.55	4.20			V								
				5																
				10										3.80	3.90	4.10	3.90			
				15												3.95	3.50			
				20										3.55	3.40	3.75				
				25		3.40	3.10	3.55												
				0	10	9	9.10	9.55	9.20				V							
				5													9.25			
				10											8.85	9	9.15			
				15													9.05			
				20											8.70	8.60	8.90	8.40		
				25		8.60	8.30	8.75												
				0	15	14	14.10	14.55	14.20				V							
				5													14.30			
				10											13.90	14	14.20	14		
		15													14.10					
		20		13.75										13.70	13.95	13.50				
		25		13.65	13.50	13.80	13.10													
I <sub>OL</sub>	Output sink current	HCC types	0/ 5	0.4	5	0.64	0.51	1	0.36			mA								
			0/10	0.5	10	1.6	1.3	2.6	0.9											
			0/15	1.5	15	4.2	3.4	6.8	2.4											
		HCF types	0/ 5	0.4	5	0.61	0.51	1	0.42											
			0/10	0.5	10	1.5	1.3	2.6	1.1											
			0/15	1.5	15	4	3.4	6.8	2.8											
I <sub>IH</sub> , I <sub>IL</sub> **	Input leakage current	0/18	0/18	18		± 0.1	± 10 <sup>-5</sup>	± 0.1		± 1	μA									
C <sub>i</sub> **	Input capacitance						5	7.5			pF									

\* T<sub>Low</sub> = - 55°C for HCC device; -40°C for HCF device.  
 \* T<sub>High</sub> = +125°C for HCC device; +85°C for HCF device.  
 The Noise Margin for both "1" and "0" level is: 1V min. with V<sub>DD</sub> = 5V  
 2V min. with V<sub>DD</sub> = 10V  
 2.5V min. with V<sub>DD</sub> = 15V  
 \*\* Any input

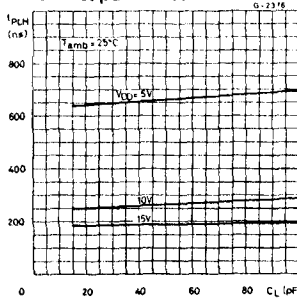
**DYNAMIC ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$ , typical temperature coefficient for all  $V_{DD}$  values is  $0.3\%/^{\circ}\text{C}$ , all input rise and fall times =  $20\text{ ns}$ )

Parameter	Test conditions	Values			Unit	
		$V_{DD}$ (V)	Min.	Typ.		Max.
$t_{PHL}$ Propagation delay time (Data)		5		520	1040	ns
		10		210	420	
		15		150	300	
$t_{PLH}$ Propagation delay time (Data)		5		660	1320	ns
		10		260	520	
		15		180	360	
$t_{PHL}$ Propagation delay time ( $\overline{\text{B}}\overline{\text{L}}$ )		5		350	700	ns
		10		175	350	
		15		125	250	
$t_{PLH}$ Propagation delay time ( $\overline{\text{B}}\overline{\text{L}}$ )		5		400	800	ns
		10		175	350	
		15		150	300	
$t_{PHL}$ Propagation delay time ( $\overline{\text{C}}\overline{\text{T}}$ )		5		250	500	ns
		10		125	250	
		15		85	170	
$t_{PLH}$ Propagation delay time ( $\overline{\text{C}}\overline{\text{T}}$ )		5		150	300	ns
		10		75	150	
		15		50	100	
$t_{TLH}$ Transition time		5		40	100	ns
		10		30	75	
		15		20	65	
$t_{THL}$ Transition time		5		125	310	ns
		10		75	185	
		15		65	160	
$t_{\text{setup}}$ Setup time		5	150	75		ns
		10	70	35		
		15	40	20		
$t_{\text{hold}}$ Hold time		5	0	-75		ns
		10	0	-35		
		15	0	-20		
$t_W$ Strobe pulse width		5	400	200		ns
		10	160	80		
		15	100	50		

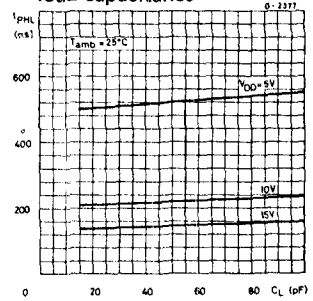
Typical output low (sink) current characteristics



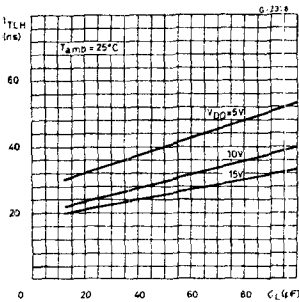
Typical data-to-output, low-to-high-level propagation delay time as a function of load capacitance



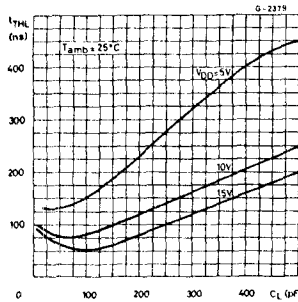
Typical data-to-output, high-to-low-level propagation delay time as a function of load capacitance



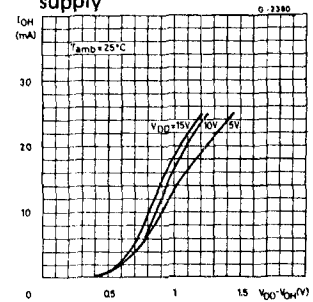
Typical low-to-high level transition time as a function of load capacitance



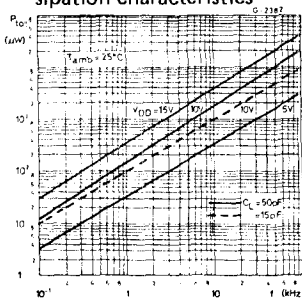
Typical high-to-low transition time as a function of load capacitance



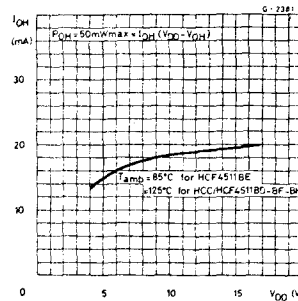
Typical voltage drop ( $V_{DD}$  to output) vs. output source current as a function of supply



Typical dynamic power dissipation characteristics



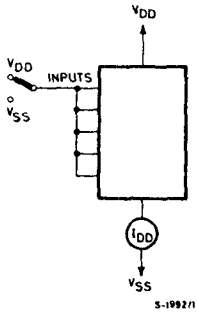
Derated static output current per output



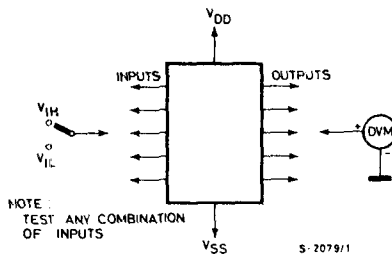
Maximum continuous derated output current  $I_{OH}$  applies to a single output with all other outputs sourcing an equal amount of current at the supply voltages shown. Operation above the derating curve is not recommended.

## TEST CIRCUITS

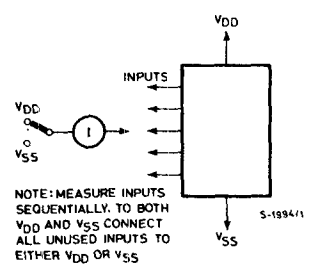
Quiescent device current



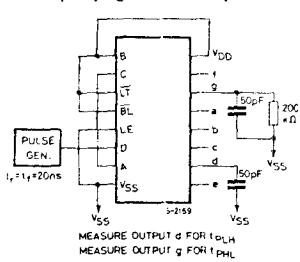
Noise immunity



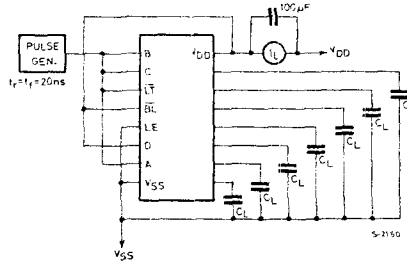
Input leakage current



Data propagation delay

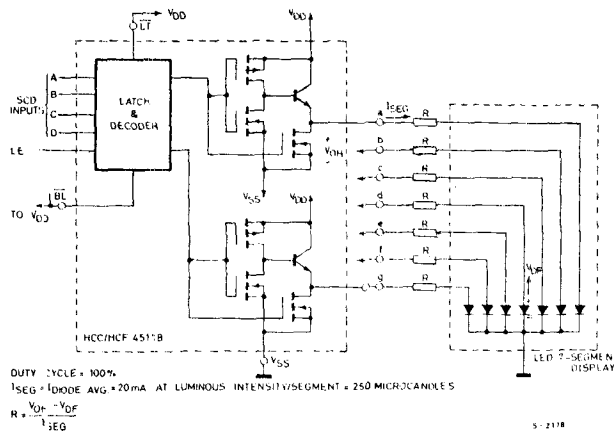


Dynamic power dissipation



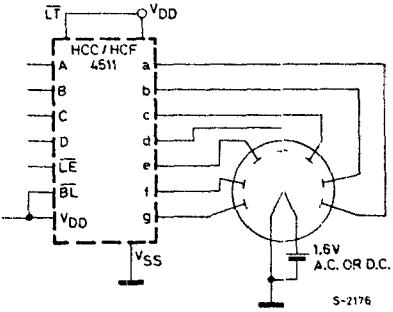
## APPLICATIONS (Interfacing with various displays)

Driving common-cathode 7-segment LED displays



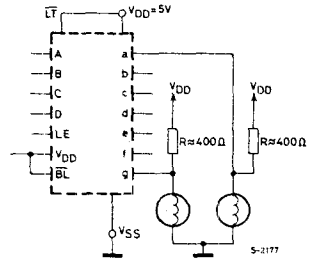
**APPLICATIONS (continued)**

**Driving low-voltage fluorescent displays**



A medium-brightness intensity display can be obtained with low-voltage fluorescent displays such as the Tung-Sot Digivac S/G Series.

**Driving incandescent displays**



**2 of 7 Segments Shown Connected**

Resistors R from V<sub>DD</sub> to each 7-segment driver output are chosen to keep all Numitron segments slightly on and warm.